

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2832487

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
GWANGCHAE JUNG	12/11/2013
MI-KYEONG KIM	12/11/2013
GYEJIN JUN	12/11/2013
MINCHUL KIM	12/11/2013
KYUHO SONG	12/11/2013
AEMIN SHIM	12/11/2013
DHOJIN HAN	12/11/2013
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO 443-742
City:	SUWON-SI
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29484790
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-429-0020
Email:	pto@nsiplaw.com
Correspondent Name:	NSIP LAW
Address Line 1:	P.O. BOX 65745
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20035
ATTORNEY DOCKET NUMBER:	D91058.0292
NAME OF SUBMITTER:	SHABNAM NOWROUZI
SIGNATURE:	/Shabnam Nowrouzi/
DATE SIGNED:	04/28/2014
Total Attachments: 4	

source=DSS13-0413-US0#page1.tif

source=DSS13-0413-US0#page2.tif

source=DSS13-0413-US0#page3.tif

source=DSS13-0413-US0#page4.tif

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

As a below-named inventor, I hereby declare that this declaration is directed to the application attached hereto, or to United States Application Number or PCT International Application Number

29/484,790 filed on March 13, 2014 (if applicable), entitled:

PRINTER

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

ASSIGNMENT

For valuable consideration, I, as a below-named assignor, hereby assign to:

Samsung Electronics Co., Ltd.
129, Samsung-ro, Yeongtong-gu
Suwon-si, Gyeonggi-do, 443-742
Republic of Korea

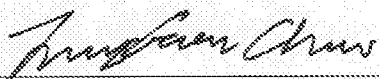
and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title, and interest throughout the world in the inventions and improvements that are the subject of the application identified in the above declaration, which is United States Application Number or PCT International Application Number 29/484,790 filed on March 13, 2014.

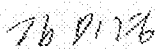
I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified


application when known, and to correct any typographical errors that may be discovered in this Assignment.

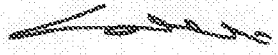
This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

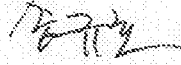
In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.


Inventor's Legal Name	GwangChae Jung		
Inventor's Signature		Date	12.11.13
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	206 ho No. 301 Samsungdong-2ga Sungbukgu Seoul Republic of Korea		


Inventor's Legal Name	Mi-kyeong Kim		
Inventor's Signature		Date	12.11.13
Residence (City, Country)	Chunan-si, Republic of Korea		
Mailing Address	201-401 Ubang U-shell apt. Sinbu-Dong Chunan-si Chungchungnamdo Republic of Korea		

Inventor's Legal Name	GYEJIN JUN		
Inventor's Signature		Date	12. 11. 13
Residence (City, Country)	Sungnam-si, Republic of Korea		
Mailing Address	805-2502 Chungsolmaul Daewon Apt. Kumkok -Dong Bundang-Ku Sungnam-si Kyungki-do Republic of Korea		

Inventor's Legal Name	Minchul Kim		
Inventor's Signature		Date	12. 11. 13
Residence (City, Country)	Buchunsi, Republic of Korea		
Mailing Address	102-801 Sosa Prugio Apt. 133-12 Sosabondong Sosa -Ku Buchunsi Kyungki-do Republic of Korea		

Inventor's Legal Name	Kyuho Song		
Inventor's Signature		Date	12. 11. 13
Residence (City, Country)	Incheon, Republic of Korea		
Mailing Address	380-1802 Hanhwa Kumaegrin Apt. 856-1 Kyungsu -Dong Su-Ku Incheon Republic of Korea		

Inventor's Legal Name	Aemin Shim		
Inventor's Signature		Date	12. 11. 13
Residence (City, Country)	Sungnam-si, Republic of Korea		
Mailing Address	234-12 Jungja-Dong Bundang-Ku Sungnam-si Kyungki-do Republic of Korea		

Inventor's Legal Name	Dhojin Han		
Inventor's Signature		Date	12. 01. 13
Residence (City, Country)	Taeku, Republic of Korea		
Mailing Address	202 ho 2241-28 Daemyung-Dong Nam-Ku Taeku Republic of Korea		